

FEATURES:

- 0.5 MICRON CMOS Technology
- Typical $t_{sk(o)}$ (Output Skew) < 250ps
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model ($C = 200\text{pF}$, $R = 0$)
- $V_{cc} = 3.3V \pm 0.3V$, Normal Range
- $V_{cc} = 2.7V$ to $3.6V$, Extended Range
- $V_{cc} = 2.5V \pm 0.2V$
- CMOS power levels ($0.4\mu\text{W}$ typ. static)
- Rail-to-Rail output swing for increased noise margin
- Available in TSSOP package

DRIVE FEATURES:

- High Output Drivers: $\pm 24\text{mA}$
- Low switching noise

APPLICATIONS:

- 3.3V high speed systems
- 3.3V and lower voltage computing systems

DESCRIPTION:

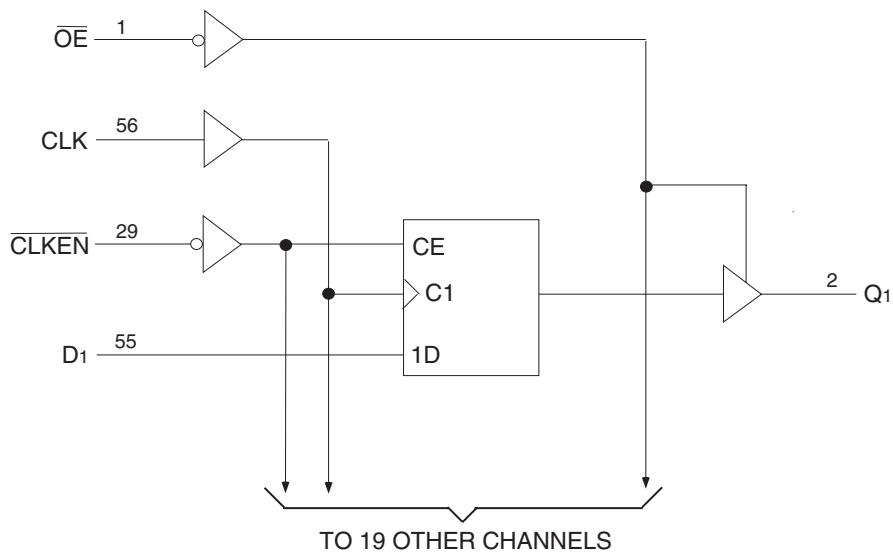
This 20-bit flip-flop is built using advanced dual metal CMOS technology. The 20 flip-flops of the ALVCH16721 are edge-triggered D-type flip-flops with qualified clock storage. On the positive transition of the clock (CLK) input, the device provides true data at the Q outputs if the clock-enable (CLKEN) input is low. If CLKEN is high, no data is stored.

A buffered output-enable (\overline{OE}) input places the 20 outputs in either a normal logic state (high or low) or a high-impedance state. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components. \overline{OE} does not affect the internal operation of the flip-flops. Old data can be retained or new data can be entered while the outputs are in the high-impedance state.

The ALVCH16721 has been designed with a $\pm 24\text{mA}$ output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance.

The ALVCH16721 has "bus-hold" which retains the inputs' last state whenever the input goes to a high impedance. This prevents floating inputs and eliminates the need for pull-up/down resistor.

FUNCTIONAL BLOCK DIAGRAM



PIN CONFIGURATION

OE	1	56	CLK
Q1	2	55	D1
Q2	3	54	D2
GND	4	53	GND
Q3	5	52	D3
Q4	6	51	D4
Vcc	7	50	Vcc
Q5	8	49	D5
Q6	9	48	D6
Q7	10	47	D7
GND	11	46	GND
Q8	12	45	D8
Q9	13	44	D9
Q10	14	43	D10
Q11	15	42	D11
Q12	16	41	D12
Q13	17	40	D13
GND	18	39	GND
Q14	19	38	D14
Q15	20	37	D15
Q16	21	36	D16
Vcc	22	35	Vcc
Q17	23	34	D17
Q18	24	33	D18
GND	25	32	GN
Q19	26	31	D19
Q20	27	30	D20
NC	28	29	CLKEN

TSSOP
TOP VIEW

ABSOLUTE MAXIMUM RATINGS⁽¹⁾

Symbol	Description	Max	Unit
VTERM ⁽²⁾	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
VTERM ⁽³⁾	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
TSTG	Storage Temperature	-65 to +150	°C
IOUT	DC Output Current	-50 to +50	mA
Iik	Continuous Clamp Current, Vi < 0 or Vi > Vcc	±50	mA
lok	Continuous Clamp Current, Vo < 0	-50	mA
Icc	Continuous Current through each Vcc or GND	±100	mA
Iss			

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- Vcc terminals.
- All terminals except Vcc.

CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter ⁽¹⁾	Conditions	Typ.	Max.	Unit
Cin	Input Capacitance	Vin = 0V	5	7	pF
Cout	Output Capacitance	Vout = 0V	7	9	pF
Ci/o	I/O Port Capacitance	Vin = 0V	7	9	pF

NOTE:

- As applicable to the device type.

PIN DESCRIPTION

Pin Names	Description
OE	3-State Output Enable Input (Active LOW)
Dx	Data Inputs ⁽¹⁾
Qx	3-State Outputs
CLK	Clock Input
CLKEN	Clock Enable Input (Active LOW)
N C	No Internal Connection

NOTE:

- These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

FUNCTION TABLE (EACH FLIP-FLOP)⁽¹⁾

Inputs				Output
OE	CLKEN	CLK	Dx	Qx
L	H	X	X	Q ₀ ⁽²⁾
L	L	↑	H	H
L	L	↑	L	L
L	L	L or H	X	Q ₀ ⁽²⁾
H	X	X	X	Z

NOTES:

- H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care
Z = High Impedance
↑ = LOW-to-HIGH transition
- Output level before the indicated steady-state input conditions were established.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition: TA = -40°C to +85°C

Symbol	Parameter	Test Conditions		Min.	Typ. ⁽¹⁾	Max.	Unit
VIH	Input HIGH Voltage Level	VCC = 2.3V to 2.7V		1.7	—	—	V
		VCC = 2.7V to 3.6V		2	—	—	
VIL	Input LOW Voltage Level	VCC = 2.3V to 2.7V		—	—	0.7	V
		VCC = 2.7V to 3.6V		—	—	0.8	
I _{IH}	Input HIGH Current	VCC = 3.6V	VI = VCC	—	—	±5	µA
I _{IL}	Input LOW Current	VCC = 3.6V	VI = GND	—	—	±5	µA
I _{OZH}	High Impedance Output Current (3-State Output pins)	VCC = 3.6V	VO = VCC	—	—	±10	µA
			VO = GND	—	—	±10	
V _{IK}	Clamp Diode Voltage	VCC = 2.3V, I _{IN} = -18mA		—	-0.7	-1.2	V
V _H	Input Hysteresis	VCC = 3.3V		—	100	—	mV
I _{CCL} I _{CCH} I _{CCZ}	Quiescent Power Supply Current	VCC = 3.6V VIN = GND or VCC		—	0.1	40	µA
ΔI _{CC}	Quiescent Power Supply Current Variation	One input at VCC - 0.6V, other inputs at VCC or GND		—	—	750	µA

NOTE:

1. Typical values are at VCC = 3.3V, +25°C ambient.

BUS-HOLD CHARACTERISTICS

Symbol	Parameter ⁽¹⁾	Test Conditions		Min.	Typ. ⁽²⁾	Max.	Unit
I _{BHH}	Bus-Hold Input Sustain Current	VCC = 3V	VI = 2V	-75	—	—	µA
			VI = 0.8V	75	—	—	
I _{BHH}	Bus-Hold Input Sustain Current	VCC = 2.3V	VI = 1.7V	-45	—	—	µA
			VI = 0.7V	45	—	—	
I _{BHHO} I _{BHLO}	Bus-Hold Input Overdrive Current	VCC = 3.6V	VI = 0 to 3.6V	—	—	±500	µA

NOTES:

1. Pins with Bus-Hold are identified in the pin description.
2. Typical values are at VCC = 3.3V, +25°C ambient.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions ⁽¹⁾		Min.	Max.	Unit
VOH	Output HIGH Voltage	VCC = 2.3V to 3.6V	I _{OH} = - 0.1mA	VCC - 0.2	—	V
		VCC = 2.3V	I _{OH} = - 6mA	2	—	
		VCC = 2.3V	I _{OH} = - 12mA	1.7	—	
		VCC = 2.7V		2.2	—	
		VCC = 3V		2.4	—	
		VCC = 3V	I _{OH} = - 24mA	2	—	
VOL	Output LOW Voltage	VCC = 2.3V to 3.6V	I _{OL} = 0.1mA	—	0.2	V
		VCC = 2.3V	I _{OL} = 6mA	—	0.4	
			I _{OL} = 12mA	—	0.7	
		VCC = 2.7V	I _{OL} = 12mA	—	0.4	
		VCC = 3V	I _{OL} = 24mA	—	0.55	

NOTE:

1. V_{IH} and V_{IL} must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V_{cc} range. T_A = - 40°C to + 85°C.

OPERATING CHARACTERISTICS, T_A = 25°C

Symbol	Parameter	Test Conditions	V _{CC} = 2.5V ± 0.2V	V _{CC} = 3.3V ± 0.3V	Unit
			Typical	Typical	
CPD	Power Dissipation Capacitance Outputs enabled	C _L = 0pF, f = 10Mhz	55	59	pF
	Power Dissipation Capacitance Outputs disabled		46	49	

SWITCHING CHARACTERISTICS⁽¹⁾

Symbol	Parameter	V _{CC} = 2.5V ± 0.2V		V _{CC} = 2.7V		V _{CC} = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
f _{MAX}		150	—	150	—	150	—	MHz
t _{PLH}	Propagation Delay CLK to Q _x	1	5.6	1	5.1	1	4.3	ns
t _{PZH}	Output Enable Time OE to Q _x	1	6.1	1	5.8	1	4.8	ns
t _{PHZ}	Output Disable Time OE to Q _x	1	5.5	1	4.7	1	4.4	ns
t _{PLZ}	Set-up Time, data before CLK↑	4	—	3.6	—	3.1	—	ns
t _{SU}	Set-up Time, CLKEN before CLK↑	3.4	—	3.1	—	2.7	—	ns
t _H	Hold Time, data after CLK↑	0	—	0	—	0	—	ns
t _H	Hold Time, CLKEN after CLK↑	0	—	0	—	0	—	ns
t _W	Pulse Width, CLK HIGH or LOW	3.3	—	3.3	—	3.3	—	ns
t _{SK(O)}	Output Skew ⁽²⁾	—	—	—	—	—	500	ps

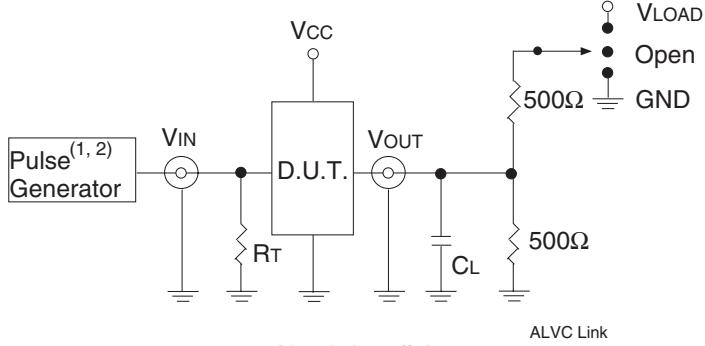
NOTES:

1. See TEST CIRCUITS AND WAVEFORMS. T_A = - 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	$V_{CC}^{(1)} = 3.3V \pm 0.3V$	$V_{CC}^{(1)} = 2.7V$	$V_{CC}^{(2)} = 2.5V \pm 0.2V$	Unit
V_{LOAD}	6	6	$2 \times V_{CC}$	V
V_{IH}	2.7	2.7	V_{CC}	V
V_T	1.5	1.5	$V_{CC} / 2$	V
V_{LZ}	300	300	150	mV
V_{HZ}	300	300	150	mV
C_L	50	50	30	pF



Test Circuit for All Outputs

DEFINITIONS:

C_L = Load capacitance: includes jig and probe capacitance.

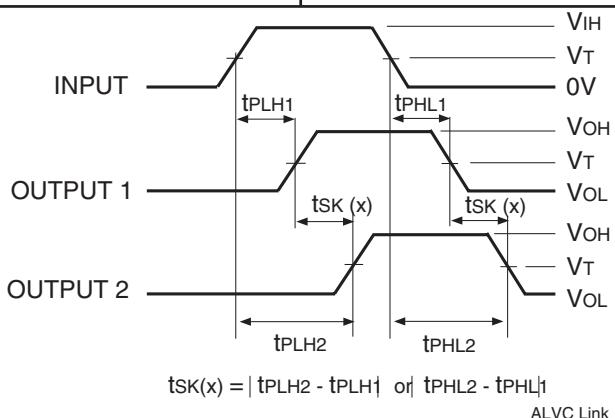
R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $t_f \leq 2.5\text{ns}$; $t_r \leq 2.5\text{ns}$.
2. Pulse Generator for All Pulses: Rate $\leq 1.0\text{MHz}$; $t_f \leq 2\text{ns}$; $t_r \leq 2\text{ns}$.

SWITCH POSITION

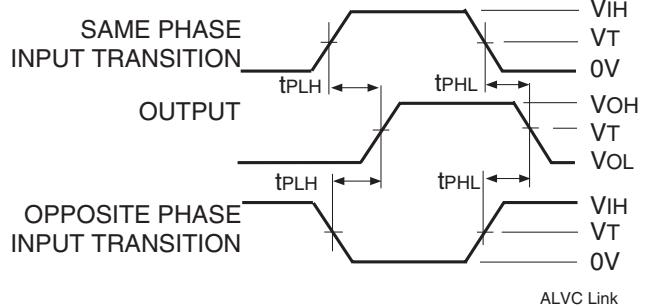
Test	Switch
Open Drain	V_{LOAD}
Disable Low	
Enable Low	
Disable High	GND
Enable High	
All Other Tests	Open



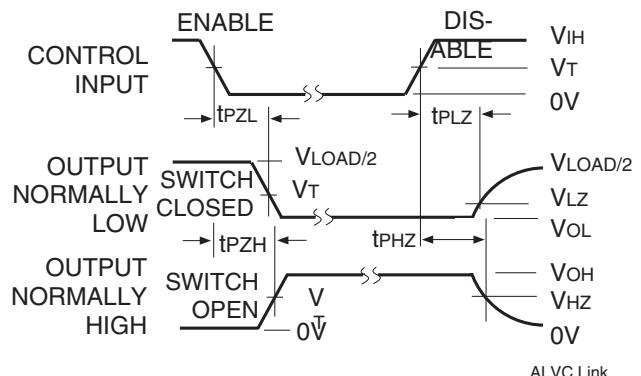
Output Skew - $t_{SK}(x)$

NOTES:

1. For $t_{SK}(o)$ OUTPUT1 and OUTPUT2 are any two outputs.
2. For $t_{SK}(b)$ OUTPUT1 and OUTPUT2 are in the same bank.



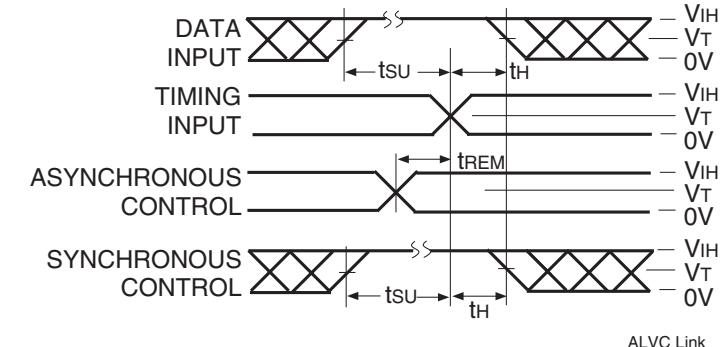
Propagation Delay



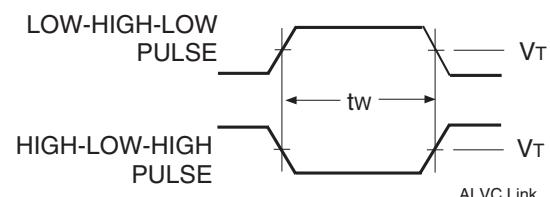
Enable and Disable Times

NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

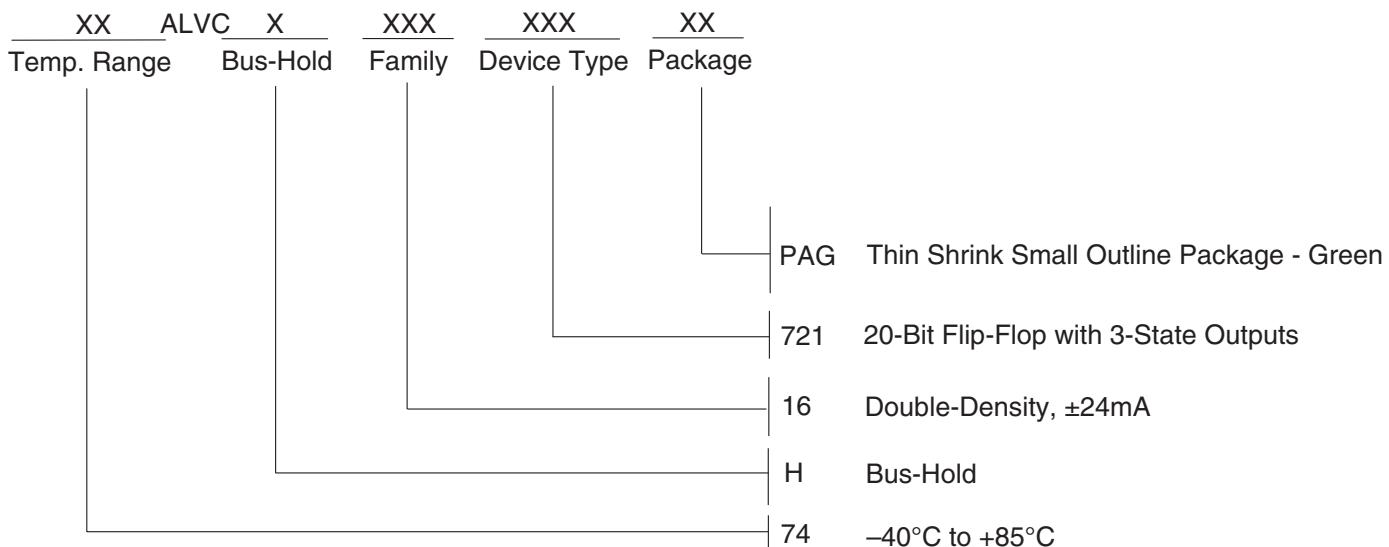


Set-up, Hold, and Release Times



Pulse Width

ORDERING INFORMATION



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